Unit: mm

TOSHIBA Field Effect Transistor Silicon P Channel MOS Type (L^2 - π -MOSV)

2SJ378

Relay Drive, DC-DC Converter and Motor Drive Applications

• 4 V gate drive

• Low drain-source ON resistance : RDS (ON) = 0.16 Ω (typ.)

• High forward transfer admittance $: |Y_{fs}| = 4.0 \text{ S (typ.)}$ • Low leakage current $: I_{DSS} = -100 \,\mu\text{A (max) (V}_{DS} = -60 \,\text{V)}$

• Enhancement-mode : $V_{th} = -0.8 \sim -2.0 \text{ V (V}_{DS} = -10 \text{ V, I}_{D} = -1 \text{ mA})$

Maximum Ratings (Ta = 25°C)

Characteri	stics	Symbol	Rating	Unit	
Drain-source voltage		V_{DSS}	-60	V	
Drain-gate voltage (R	_{GS} = 20 kΩ)	V_{DGR}	-60	V	
Gate-source voltage		V_{GSS}	±20	V	
Drain current	DC (Note 1)	I _D	-5	Α	
	Pulse(Note 1)	I _{DP}	-20	Α	
Drain power dissipation	n	P_{D}	1.3	W	
Single pulse avalanch	e energy (Note 2)	E _{AS}	273	mJ	
Avalanche current		I _{AR}	-5	Α	
Repetitive avalenche	energy (Note 3)	E _{AR}	0.13	mJ	
Channel temperature		T _{ch}	150	°C	
Storage temperature range		T _{stg}	-55~150	°C	

1.4±0.1 1.05±0.1 1.05±0.1 1.05±0.1 1.05±0.1 2.5±0.5 1.50URCE 2.07 2.5±0.5 2.5±0

2-8M1B

Weight: 0.54 g (typ.)

JEITA TOSHIBA

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to ambient	R _{th (ch-a)}	96.1	°C/W

Note 1: Please use devices on condition that the channel temperature is below 150°C.

Note 2: $V_{DD} = -25 \text{ V}$, $T_{ch} = 25 ^{\circ}\text{C}$ (initial), L = 14.84 mH, $R_G = 25 \Omega$, $I_{AR} = -5 \text{ A}$

Note 3: Repetitive rating: Pulse width limited by maximum channel temperature

This transistor is an electrostatic sensitive device.

Please handle with caution.

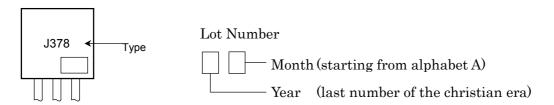
Electrical Characteristics (Ta = 25°C)

Charac	eteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	ırrent	I _{GSS}	V _{GS} = ±16 V, V _{DS} = 0 V	_	_	±10	μΑ
Drain cut-off cu	rrent	I _{DSS}	V _{DS} = -60 V, V _{GS} = 0 V	_	_	-100	μΑ
Drain-source br	eakdown voltage	V _{(BR) DSS}	$I_D = -10 \text{ mA}, V_{GS} = 0 \text{ V}$	-60	_	_	٧
Gate threshold v	voltage	V_{th}	$V_{DS} = -10 \text{ V}, I_D = -1 \text{ mA}$	-0.8	_	-2.0	٧
Drain-source ON resistance		R _{DS (ON)}	$V_{GS} = -4 \text{ V}, I_D = -2.5 \text{ A}$	_	0.24	0.28	Ω
			$V_{GS} = -10 \text{ V}, I_D = -2.5 \text{ A}$	_	0.16	0.19	12
Forward transfe	r admittance	Y _{fs}	$V_{DS} = -10 \text{ V}, I_D = -2.5 \text{ A}$	2.0	4.0	_	S
Input capacitano	e	C _{iss}		_	630	_	pF
Reverse transfe	r capacitance	C _{rss}	V _{DS} = -10 V, V _{GS} = 0 V, f = 1 MHz	_	95	_	
Output capacitance		Coss		_	290	_]
Switching time	Rise time	t _r	V_{GS} V_{OV}	_	25	_	
	Turn-on time	t _{on}		_	45	_	no
	Fall time	t _f		_	55	_	ns ns
	Turn-off time	t _{off}	Duty $\leq 1\%$, $t_{\rm W} = 10 \mu \rm s$	_	200	_	
Total gate charge (Gate-source plus gate-drain)		Qg			22		nC
Gate-source charge		Q _{gs}	$V_{DD} \approx -48 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -5 \text{ A}$		16	_	
Gate-drain ("miller") charge		Q _{gd}		_	6	_	

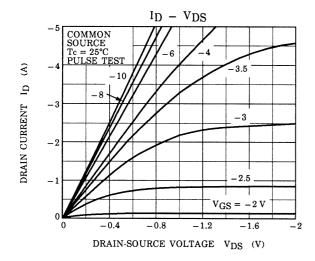
Source-Drain Ratings and Characteristics (Ta = 25°C)

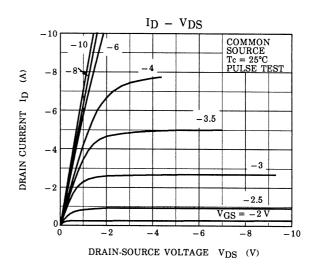
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	_	_	_	-5	Α
Pulse drain reverse current (Note 1)	I _{DRP}	_	-	_	-20	Α
Forward voltage (diode)	V _{DSF}	I _{DR} = -5 A, V _{GS} = 0 V	_	_	1.7	V
Reverse recovery time	t _{rr}	I _{DR} = -5 A, V _{GS} = 0 V	_	80	_	ns
Reverse recovery charge	Qrr	dI_{DR} / $dt = 50 A / \mu S$	_	0.1	_	μC

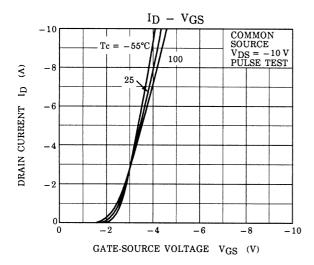
Marking

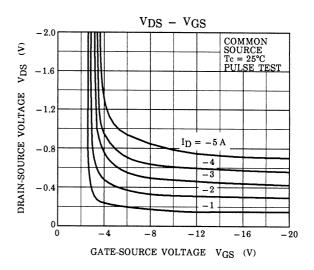


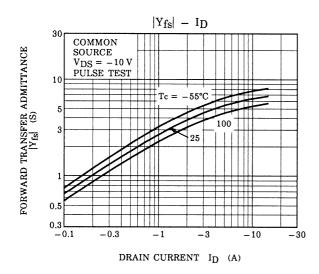
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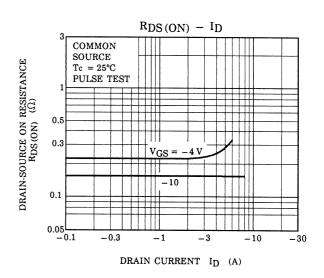




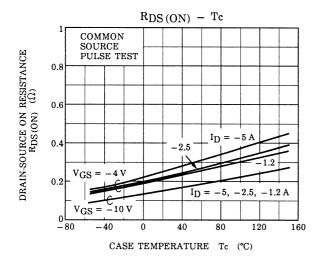


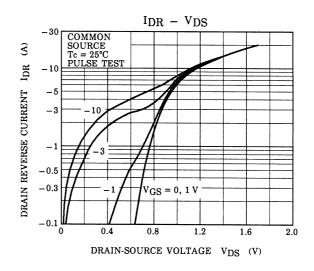


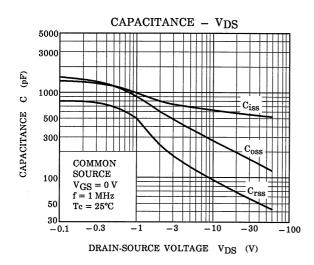


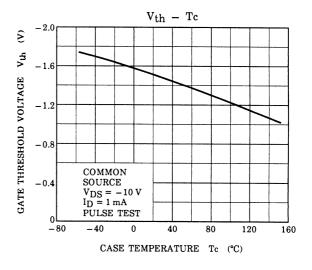


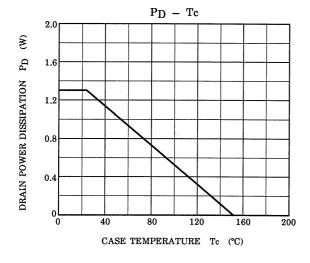
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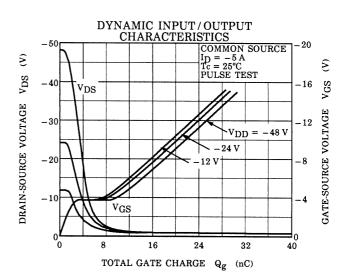




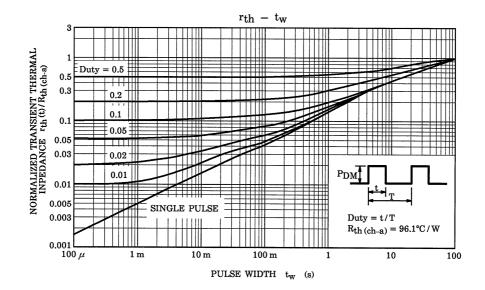


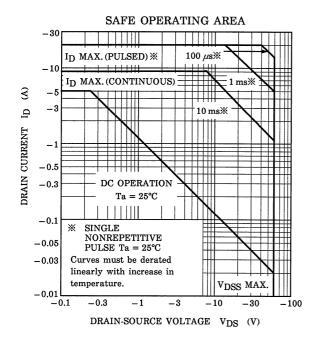


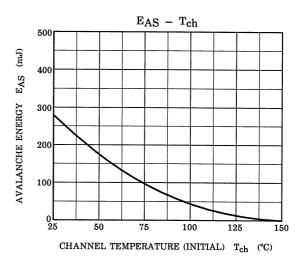


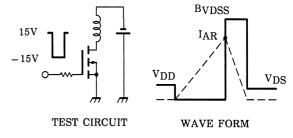


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$$\begin{array}{ll} R_G\!=\!25\Omega \\ V_{DD}\!=\!-25V,\; L\!=\!14.84mH \end{array} \quad E_{AS}\!=\!\frac{1}{2}\cdot L\cdot I^2\cdot (\frac{BV_{DSS}}{BV_{DSS}\!-\!V_{DD}})$$

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